

## **Final Product Change Notification**

202403005F01 : i.MX 8M Nano Assembly Site Expansion from ATK4 to NXP-ATTJ

**Note:** This notice is NXP Company Proprietary.

#### Issue Date: Mar 31, 2024 Effective Date: Jun 29, 2024

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### Management summary

NXP Semiconductors announces the Assembly site expansion for the i.MX 8M Nano. Change Category

[]Test

[]Test

Process

[]Design

[]Frrata

[ ]Wafer Fab Process	[]Assembly Process	[]Product Marking
[]Wafer Fab	[]Assembly	[]Mechanical Specification

Materials	Materials		Equipment	t
[ ]Wafer Fab Location	[X]Assembly Location	, []Packing/Shipping/Labeling	[]Test Location	[]Electrical spec./Test coverage

[]Firmware []Other

# Notification Overview Description

NXP Semiconductors announces the Assembly site expansion for i.MX 8M Nano associated with this notification. In addition to the current Amkor ATK4, Kwangju, Korea assembly facility, the new NXP-ATTJ, Tianjin, China assembly facility plant will be expanded.

Assembly site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

#### Reason

Qualification of the NXP-ATTJ, Tianjin, China is required for manufacturing flexibility and customer supply assurance.

#### Identification of Affected Products

Top Side Marking

The assembly site, among other information, is reflected in the package trace code. The format for NXP standard trace code is AWLYYWWZ: A=Assembly Site, WL=Wafer Lot, YY=Year, WW=Work Week, Z=The Assembly Lot Split code.

Assembly site marking for ATK4 is A = 'SB'. Assembly site marking for NXP-ATTJ is A = 'CT'. **Product Availability** 

#### Sample Information

Samples are available upon request PIMX8MN6CVTIZAA PIMX8MN6DVTJZAA PIMX8MN5CVTIZAA PIMX8MN5DVTJZAA Production Planned first shipment Jul 30, 2024 Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality **Disposition of Old Products** NXP will reserve the right to ship from both locations based on market demand situation. **Additional information** 

Self qualification:<u>view online</u> Additional documents: <u>view online</u>

### Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Apr 30, 2024.

## **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Position Product Marketing

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

#### NXP Quality Management Team.

#### **About NXP Semiconductors**

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